

calculating the losses due to a finite  $\kappa$ . In mathematical notation, this reads

$$\lim_{t \rightarrow 0} \left[ \lim_{\kappa \rightarrow \infty} \left| \delta(\kappa) \ll t \right| \right] \neq \lim_{\kappa \rightarrow \infty} \left[ \lim_{t \rightarrow 0} \dots \right].$$

### III. CONCLUSIONS

When calculating the conductor loss of planar transmission lines by means of perturbation methods, the assumption of zero strip thickness becomes critical: the surface current integral at the strip edges does not exist. In the numerical analysis, the results for the attenuation constant do not converge. For an increasing number  $M$  of spectral eigenfunctions,  $\alpha_c$  approaches infinity. However,  $\alpha_c$  shows a logarithmic dependence on  $M$  so that, in practice, the unbounded behavior may be easily overlooked or misinterpreted. As a consequence, attenuation results obtained on the basis of zero-strip-thickness approaches, such as the common spectral-domain technique, should be handled very critically and checked against measurements.

### ACKNOWLEDGMENT

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## A Closed-Form Spatial Green's Function for the Thick Microstrip Substrate

Y. L. Chow, J. J. Yang, D. G. Fang, and G. E. Howard

**Abstract**—The spatial Green's function for the open microstrip structure, especially with a thick substrate, is generally represented by time-consuming Sommerfeld integrals. In this paper, through the Sommerfeld identity, a closed-form spatial Green's function of a few terms is found from the quasi-dynamic images, the complex images, and the surface waves. With the numerical integration of the Sommerfeld integrals thus avoided, this closed-form Green's function is computa-

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Y. L. Chow, J. J. Yang, and G. E. Howard are with the Department of Electrical and Computer Engineering, University of Waterloo, Waterloo, Ont., Canada N2L 3G1.

D. G. Fang is with the East China Institute of Technology, Nanjing, China 210014.

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tionally very efficient. Numerical examples show that the closed-form Green's function gives less than 1% error for all substrates and source-to-field distances.

### I. INTRODUCTION

In the modeling of microwave integrated circuits (MIC's) and microstrip antennas, much effort has to be dedicated to the computation of Sommerfeld integrals. For a thin microstrip substrate, say  $h/\lambda_e < 0.05$ , the quasi-dynamic image model intuitively developed by Chow [1] is a good replacement for the Sommerfeld integrals. For a thick substrate and when the distance from the source point to the field point is great, however, this replacement deteriorates because of its neglect of the surface and leaky wave effects. To accurately model the thick-substrate microstrip circuits, it appears that the time-consuming numerical integration of Sommerfeld integrals has to be performed [2], [3]. Although the exact image method was developed for the microstrip structure [4], where the Sommerfeld integrals were replaced by certain alternative infinite integrals, it was shown in [5] that this alternative type of numerical integration is still rather time-consuming.

In this paper, a closed-form Green's function for a thick microstrip substrate is presented. This Green's function consists of three parts:  $G = A + B + C$ , where  $A$  represents the contribution from a few quasi-dynamic images dominating in the near-field region,  $C$  represents the contribution from surface waves dominating in the far-field region of the substrate surface, and  $B$  represents the contribution from the complex images, which are related to leaky waves and are very important in the intermediate field region. With this closed form, numerical integration of Sommerfeld integrals is completely avoided. It will be shown below numerically that at any frequency, this closed-form Green's function gives less than 1% error compared with the numerical integration of Sommerfeld integrals in the whole range of substrate surfaces.

### II. THEORY

Consider an  $x$ -directed electric dipole of unit strength located above a microstrip substrate, as shown in Fig. 1. The spectral-domain potentials in the air region can be represented as follows:

$$\tilde{G}_A^{xx} = \frac{\mu_0}{4\pi} \frac{1}{j2k_{z0}} \left[ e^{-jk_{z0}(z-z')} + R_{TE} e^{-jk_{z0}(z+z')} \right] \quad (1a)$$

$$\tilde{G}_q = \frac{1}{4\pi\epsilon_0} \frac{1}{j2k_{z0}} \left[ e^{-jk_{z0}(z-z')} + (R_{TE} + R_q) e^{-jk_{z0}(z+z')} \right] \quad (1b)$$

where

$$R_{TE} = -\frac{r_{10}^{TE} + e^{-j2k_{z1}h}}{1 + r_{10}^{TE} e^{-j2k_{z1}h}} \quad (2a)$$

$$R_q = \frac{2k_{z0}^2(1-\epsilon_r)(1-e^{-j4k_{z1}h})}{(k_{z1}+k_{z0})(k_{z1}+\epsilon_r k_{z0})(1+r_{10}^{TE} e^{-j2k_{z1}h})(1-r_{10}^{TM} e^{-j2k_{z1}h})} \quad (2b)$$

$$r_{10}^{TE} = \frac{k_{z1}-k_{z0}}{k_{z1}+k_{z0}} \quad r_{10}^{TM} = \frac{k_{z1}-\epsilon_r k_{z0}}{k_{z1}+\epsilon_r k_{z0}} \quad (3)$$

$$k_{z0}^2 + k_p^2 = k_0^2 \quad k_{z1}^2 + k_p^2 = \epsilon_r k_0^2 \quad (4)$$

In (1),  $\tilde{G}_A^{xx}$  stands for the  $x$  component of spectral-domain vector potential  $\tilde{A}$  created by the  $x$ -directed electric dipole, and  $\tilde{G}_q$  stands for the spectral-domain scalar potential associated with one charge of the dipole.  $R_{TE}$  and  $R_q$  take into account the effects of the microstrip substrate. The spectral-domain Green's functions of (1) were given in a more compact form by

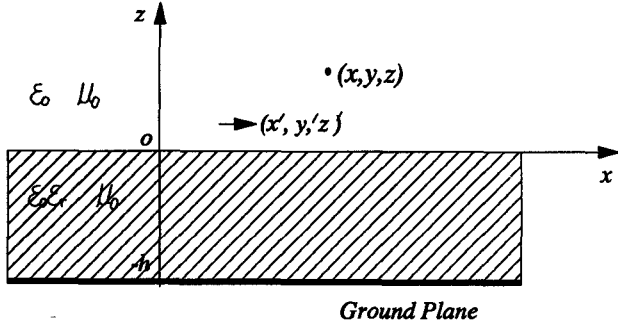


Fig. 1. The open microstrip structure.

Mosig and Gardiol [2]. Here we write them in the form of plane wave summations. It can be seen below that this form is physically clearer for deriving the quasi-dynamic and complex images.

#### A. Sommerfeld Integrals with a Deformed Integration Path

Making the inverse Hankel transformation to the spectral-domain Green's function in (1), and using the Sommerfeld identity [6] on the first exponential term, we can get the following spatial-domain Green's functions in Sommerfeld integral form:

$$G_A^{xx} = \frac{\mu_0}{4\pi} \left( \frac{e^{-jk_0 r_0}}{r_0} + \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} R_{TE} e^{-jk_{z0}(z+z')} \cdot H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \right) \quad (5a)$$

$$G_q = \frac{1}{4\pi\epsilon_0} \left( \frac{e^{-jk_0 r_0}}{r_0} + \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} (R_{TE} + R_q) e^{-jk_{z0}(z+z')} \cdot H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \right) \quad (5b)$$

where

$$r_0 = \sqrt{\rho^2 + (z - z')^2}.$$

The integration can be performed along the real axis  $C_0$  on the complex  $k_\rho$  plane or along any other deformed path  $C_1$  passing through the origin and lying in the first and third quadrants, as shown in Fig. 2(a). The integration path  $C_0$  can be deformed to  $C_1$ , since no singularity is encountered in the deformation. The corresponding paths of  $C_0$  and  $C_1$  on the complex  $k_{z0}$  plane are shown in Fig. 2(b). The deformed path  $C_1$  is of special importance in finding the complex images and will be discussed in subsection II-D.

#### B. Extraction of Quasi-Dynamic Images

It is seen from (4) that if the frequency is equal to zero, then  $k_0 = 0$  and  $k_{z0} = k_{z1}$ . Therefore when the frequency is low, we can use the approximation  $k_{z0} \approx k_{z1}$ , and  $R_{TE}$  and  $R_q$  can thus be reduced to the quasi-dynamic forms:

$$R_{TE} \rightarrow \bar{R}_{TE0} = -e^{-j2k_{z0}h} \quad (6a)$$

$$R_q \rightarrow \bar{R}_{q0} = \frac{K(1 - e^{-j4k_{z0}h})}{1 - Ke^{-j2k_{z0}h}} \quad (6b)$$

where  $K = (1 - \epsilon_r)/(1 + \epsilon_r)$ . Extracting the above quasi-dynamic terms from the integrands in (5) and using the Sommerfeld

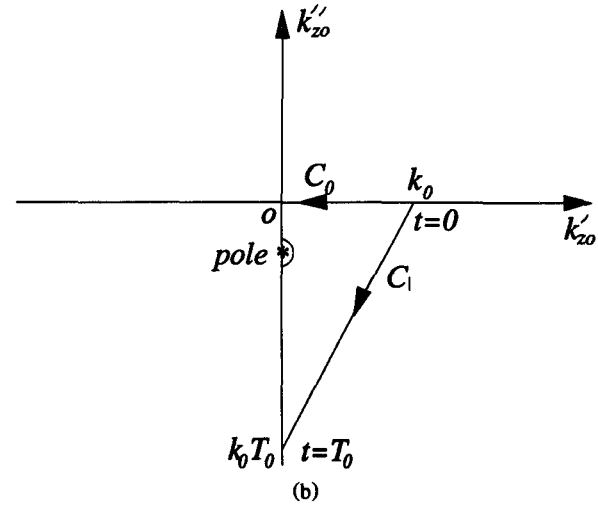
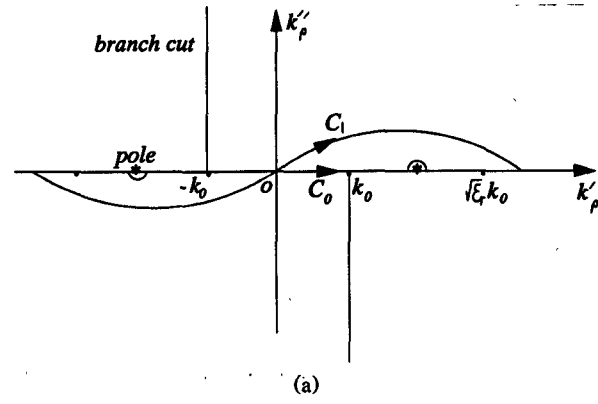


Fig. 2. (a) The integration contours  $C_0$  and  $C_1$  on the complex  $k_\rho$  plane. (b) The integration contours  $C_0$  and  $C_1$  on the complex  $k_{z0}$  plane.

identity, we can rewrite (5) as follows:

$$G_A^{xx} = G_{A0}^{xx} + \frac{\mu_0}{4\pi} \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} (R_{TE} - R_{TE0}) \cdot e^{-jk_{z0}(z+z')} H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \quad (7a)$$

$$G_q = G_{q0} + \frac{1}{4\pi\epsilon_0} \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} (R_{TE} + R_q - R_{TE0} - R_{q0}) \cdot e^{-jk_{z0}(z+z')} H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \quad (7b)$$

where

$$G_{A0}^{xx} = \frac{\mu_0}{4\pi} \left( \frac{e^{-jk_0 r_0}}{r_0} - \frac{e^{-jk_0 r'_0}}{r'_0} \right) \quad (8a)$$

$$G_{q0} = \frac{1}{4\pi\epsilon_0} \left( \frac{e^{-jk_0 r_0}}{r_0} + K \frac{e^{-jk_0 r'_0}}{r'_0} + \sum_{n=1}^{\infty} K^{n-1} (K^2 - 1) \frac{e^{-jk_0 r_n}}{r_n} \right) \quad (8b)$$

$$r'_0 = \sqrt{\rho^2 + (z + z' + 2h)^2} \quad r''_0 = \sqrt{\rho^2 + (z + z')^2}$$

$$r_n = \sqrt{\rho^2 + (z + z' + 2nh)^2}.$$

Expression (8) stands for the quasi-dynamic image model intuitively developed by Chow [1]. It is pointed out in [1] that the Faraday field (related to  $\vec{A}$ ) is not affected by the dielectric interfaces, while the Coloumb field is affected by the dielectric

interfaces through an infinite number of images. From the viewpoint of spectral-domain analysis, this quasi-dynamic model is a low-frequency approximation of the full-wave solution.

It has been pointed out by Dai and Chow [7] that when  $\epsilon_r$  is large,  $G_{q0}$  in (8b) is a slowly convergent series. For instance, if  $\epsilon_r = 12.9$ ,  $h/\lambda_0 = 0.05$ , as many as 80 terms should be taken to ensure the convergence. In [7], a reduced image model was presented, in which only four images are necessary. Such reduction is not necessarily unique. Here a simpler alternative reduced image scheme is given below.

Expanding the  $R_{q0}$  of (6b) in Taylor series and taking only the two leading terms, we have

$$R_{q0} \approx K(1 - e^{-j4k_{z0}h})(1 + Ke^{-j2k_{z0}h}). \quad (9)$$

Corresponding to (9), the quasi-dynamic Green's function for the scalar potential should be as follows:

$$G_{q0} = \frac{1}{4\pi\epsilon_0} \left( \frac{e^{-jk_0 r_0}}{r_0} + K \frac{e^{-jk_0 r_0''}}{r_0''} + K^2 \frac{e^{-jk_0 r_1}}{r_1} - \frac{Ke^{-jk_0 r_2}}{r_2} - K^2 \frac{e^{-jk_0 r_3}}{r_3} \right) \quad (10)$$

where (10) is a part (but not term by term) of the infinite series in (8b). The contribution from the remaining part of the infinite series will be included in the complex images discussed later.

### C. Extraction of Surface Waves

$R_{TE}$  and  $R_q$  in the integrands of (7) have poles on the real axis of the complex  $k_\rho$  plane. Extracting all the poles from  $R_{TE}$  and  $R_q$ , we can rewrite (7) as follows:

$$G_A^{xx} = G_{A0}^{xx} + G_{A,sw}^{xx} + \frac{\mu_0}{4\pi} \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} F_1(k_\rho) e^{-jk_{z0}(z+z')} \cdot H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \quad (11a)$$

$$G_q = G_{q0} + G_{q,sw} + \frac{1}{4\pi\epsilon_0} \int_{-\infty}^{+\infty} \frac{1}{j2k_{z0}} F_2(k_\rho) e^{-jk_{z0}(z+z')} \cdot H_0^{(2)}(k_\rho \rho) k_\rho dk_\rho \quad (11b)$$

where

$$G_{A,sw}^{xx} = \frac{\mu_0}{4\pi} (-2\pi j) \text{Res}_1 H_0^{(2)}(k_\rho \rho) k_\rho \quad (12a)$$

$$G_{q,sw} = \frac{1}{4\pi\epsilon_0} (-2\pi j) \text{Res}_2 H_0^{(2)}(k_\rho \rho) k_\rho \quad (12b)$$

are the extracted terms corresponding to surface waves. Also,  $k_{\rho p}$  is the surface wave pole located on the real axis of the complex  $k_\rho$  plane, and Res is the residue of the integrand in (7), at the pole  $k_\rho = k_{\rho p}$ .  $F_1(k_\rho)$  and  $F_2(k_\rho)$  are spectral-domain quantities with the quasi-dynamic part and surface waves extracted. In addition,

$$\text{Res}_1 = \sum_{p(\text{TE})} \left[ \frac{e^{-jk_{z0}(z+z')}}{j2k_{z0}} \right]_{k_\rho = k_{\rho p}} \lim_{k_\rho \rightarrow k_{\rho p}} (k_\rho - k_{\rho p}) R_{TE} \quad (13a)$$

$$\text{Res}_2 = \sum_{p(\text{TE}, \text{TM})} \left[ \frac{e^{-jk_{z0}(z+z')}}{j2k_{z0}} \right]_{k_\rho = k_{\rho p}} \lim_{k_\rho \rightarrow k_{\rho p}} (k_\rho - k_{\rho p}) (R_{TE} + R_q) \quad (13b)$$

$$F_1(k_\rho) = R_{TE} - R_{TE0} - \frac{2k_{\rho p} \text{Res}_1}{k_\rho^2 - k_{\rho p}^2} j2k_{z0} e^{jk_{z0}(z+z')} \quad (14a)$$

$$F_2(k_\rho) = R_{TE} + R_q - R_{TE0} - R_{q0} - \frac{2k_{\rho p} \text{Res}_2}{k_\rho^2 - k_{\rho p}^2} j2k_{z0} e^{jk_{z0}(z+z')}. \quad (14b)$$

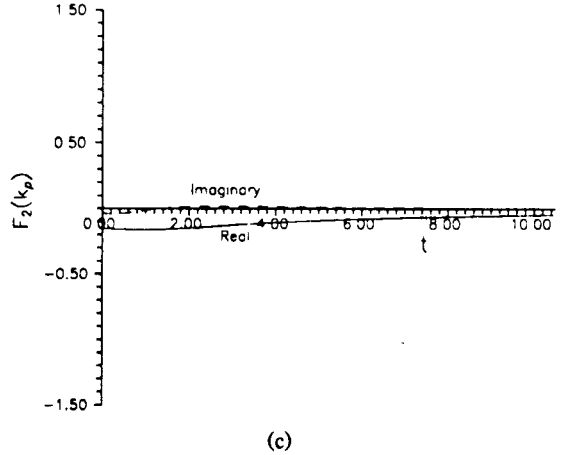
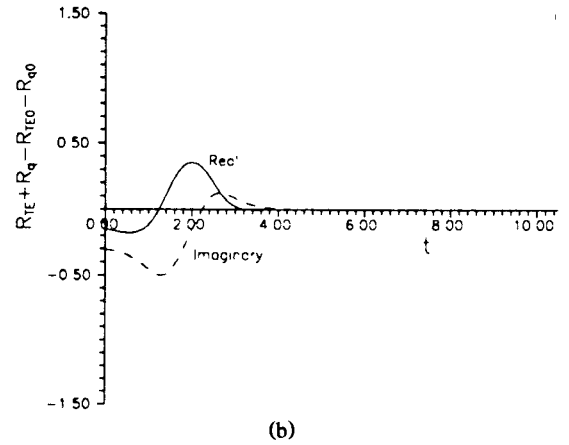
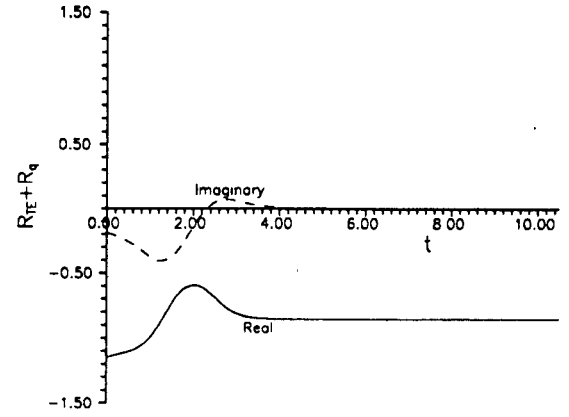


Fig. 3. (a) The behavior of the spectral function ( $R_{TE} + R_q$ ) along the path  $C_1$ . (b) The spectral function ( $R_{TE} + R_q$ ) with the quasi-dynamic term extracted. (c) The spectral function ( $R_{TE} + R_q$ ) with the quasi-dynamic and surface wave terms extracted (see eq. (14b)).

The surface wave expressions have been used by Mosig and Gardiol [2] as a far-field approximation on the substrate interface. Here we take it as a constitutive part of the wave solution for all distances  $\rho$ .

### D. Complex Images

The remaining integrals in (11) can be simulated by several complex images, similar to those in [5]. Here, in Fig. 2(a) and Fig. 2(b), we choose a finite path  $C_1$  to be a straight line on the complex  $k_{z0}$  plane, which corresponds to a finite curve  $C_1$  on the complex  $k_\rho$  plane. The parametric equation of the straight

TABLE I  
AMPLITUDES  $a_i$  AND LOCATIONS  $b_i$  OF THREE COMPLEX IMAGES  
( $\epsilon_r = 12.6$ ,  $h = 1$  mm,  $f = 30$  GHz,  $T_0 = 15.0$ )

$i$	$G_A^{xx}$				$G_q$			
	$a_i$		$b_i$		$a'_i$		$b'_i$	
	Real Part	Imaginary Part	Real Part	Imaginary Part	Real Part	Imaginary Part	Real Part	Imaginary Part
1	-0.2760	-0.0022	-0.0453	0.0001	-0.0678	0.0068	-0.0523	0.0101
2	-0.6067	0.0100	-0.2624	-0.0015	-0.1548	-0.0151	-0.2712	-0.0139
3	0.8868	0.0547	-1.2064	-0.0897	0.0897	0.0171	-1.0598	-0.3165

line is

$$C_1: k_{z0} = k_0 \left[ -jt + \left( 1 - \frac{t}{T_0} \right) \right], \quad 0 \leq t \leq T_0 \quad (15)$$

where  $t$  is the running parameter and  $T_0$  is the truncation point.  $T_0$  should be larger than  $\sqrt{\epsilon_r}$  to avoid the remnants of the extracted surface wave poles. Beyond this point, the choice of  $T_0$  is quite arbitrary. In the numerical computation of this paper,  $T_0$  is taken as 15. Other values of  $T_0$  (eg.,  $T_0 = 5$  and 10) have been tried, and they give the same results for  $G_A^{xx}$  and  $G_q$ .

We now represent  $F_1(k_\rho)$  and  $F_2(k_\rho)$  by exponential forms of the complex variable  $k_{z0}$  of (15):

$$F_1(k_\rho) = \sum_{i=1}^N a_i e^{-b_i k_{z0}} = \sum_{i=1}^N A_i e^{B_i t} \quad (16a)$$

$$F_2(k_\rho) = \sum_{i=1}^N a'_i e^{-b'_i k_{z0}} = \sum_{i=1}^N A'_i e^{B'_i t} \quad (16b)$$

where

$$a_i = A_i e^{B_i T_0 / (1 + jT_0)} \quad b_i = B_i \frac{T_0}{k_0(1 + jT_0)} \quad (17)$$

and similarly for  $a'_i$  and  $b'_i$ . A complex function of a real variable of a finite range can be approximated by the summation of exponential functions, using Prony's method [9]. Therefore when the transformation of (15) changes the complex variable  $k_{z0}$  into a real variable  $t$ , Prony's method can be used.

Substituting (16) into (11) and using the Sommerfeld identity (to avoid the necessity of numerical integrations in  $k_\rho$ ), we have

$$G_A^{xx} = G_{A0}^{xx} + G_{A,ci}^{xx} + G_{A,sw}^{xx} \quad (18a)$$

$$G_q = G_{q0} + G_{q,ci} + G_{q,sw} \quad (18b)$$

where

$$G_{A,ci}^{xx} = \frac{\mu_0}{4\pi} \sum_{i=1}^N a_i \frac{e^{-jk_0 r_i}}{r_i} \quad (19a)$$

$$G_{q,ci} = \frac{1}{4\pi\epsilon_0} \sum_{i=1}^N a'_i \frac{e^{-jk_0 r'_i}}{r'_i} \quad (19b)$$

$$r_i = \sqrt{\rho^2 + (z + z' - jb_i)^2} \quad r'_i = \sqrt{\rho^2 + (z + z' - jb'_i)^2}.$$

The subscript  $ci$  means complex image;  $r_i$  and  $r'_i$  are complex distances; and  $a_i$  and  $a'_i$  are complex amplitudes. Each term in (19) represents a complex image.

Expression (18) is the final closed-form spatial Green's function. it can be seen from (18) that  $G_A^{xx}$  or  $G_q$  is composed of three parts. The first part is the quasi-dynamic images, which

are dominant in the near field region. The third part comprises the surface waves, which are dominant in the far field region of the substrate surface. The second part is very important in the intermediate region, and is related to leaky waves.

#### E. Discussion of the Behavior of $R_{TE} + R_q$

It is interesting to see the behavior of spectral function  $R_{TE} + R_q$  along the path  $C_1$  on the complex  $k_{z0}$  plane, since this spectral function embodies all the field characteristics on the microstrip substrate. Fig. 3(a) shows the behavior of  $R_{TE} + R_q$  for a microstrip substrate ( $\epsilon_r = 12.6$ ,  $h = 1$  mm) at 30 GHz. Two salient features are observed. The first is that  $R_{TE} + R_q$  does not vanish when  $k_\rho$  is large, which implies that the quasi-dynamic terms are involved. The second is that  $R_{TE} + R_q$  has two sharp extrema along path  $C_1$ , which implies that the surface wave terms are involved. Fig. 3(b) shows the behavior of the spectral function ( $R_{TE} + R_q - R_{TE0} - R_{q0}$ ) along path  $C_1$ , i.e., with the quasi-dynamic terms extracted. It can be seen that this function decays rapidly but still has the two sharp extrema. With the surface wave poles also extracted, Fig. 3(c) shows the behavior of the resulting function  $F_2(k_\rho)$  along path  $C_1$ . It can be seen that the sharp extrema completely vanish, but the decay along  $C_1$  is actually slower than that in Fig. 3(b). This spectral function  $F_2(k_\rho)$  is associated with leaky waves. Despite the slow decay, we can simulate these leaky waves by a few complex images. Similar behavior is observed in  $F_1(k_\rho)$ .

### III. NUMERICAL RESULTS

A microstrip substrate with  $\epsilon_r = 12.6$ ,  $h = 1$  mm is examined at three different frequencies ( $f = 10$  GHz, 30 GHz, 50 GHz). A typical set of three complex images at 30 GHz with  $T_0$  of (15) taken as 15 is listed in Table I.

Parts (a) and (b) of Fig. 4 show the amplitudes of the Green's functions computed by the closed forms (18) and by numerical integration. It can be seen that the difference between the closed-form Green's function and numerical integration is nearly unobservable; i.e., the difference is generally less than 1%. Many examples to check the precision of the closed-form Green's function (18) have been calculated. They are not included here because of limits on space.

### IV. CONCLUSION

Through the Sommerfeld equality, plus some analytical and numerical techniques, a closed-form Green's function for thick microstrip substrate is presented. With this closed form, the numerical integration of the Sommerfeld integrals can be avoided completely, resulting in a significant reduction of computer time. A typical example is that, for the substrate of  $\epsilon_r = 12.6$ ,  $h/\lambda_0 = 0.1$ , the closed-form Green's function for the scalar potential is only a ten-term expression: five terms for the

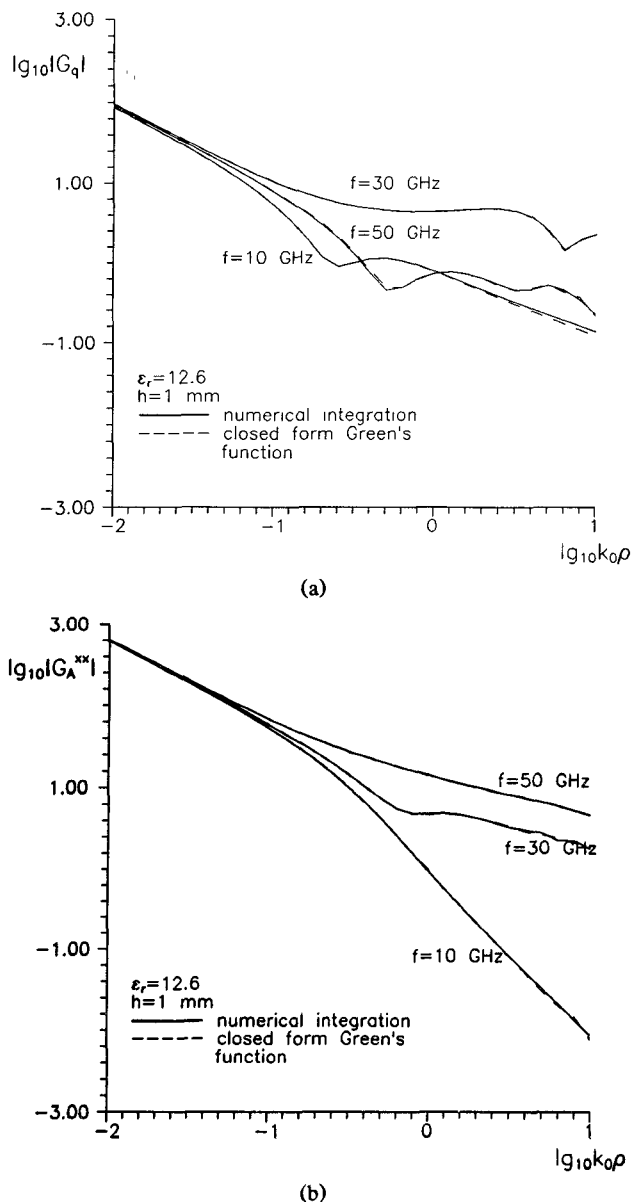


Fig. 4. (a) The amplitude of the scalar potential  $G_q$ . (b) The amplitude of the vector potential  $G_A^{xx}$ .

quasi-dynamic images (i.e., eq. (10)), three terms for the complex images (i.e., Table I), and two terms for the surface waves. The savings in computer time can be more than tenfold, with the error less than 1% compared with the numerical integration of the Sommerfeld integrals.

Finally, it should be pointed out that the closed-form equation (18) applies to all source-to-field distances on the substrate surface. As discussed in the Introduction, it is in the form  $A + B + C$ , representing the contributions of the quasi-dynamic images, the complex images, and the surface wave. At different distances, certain contributions may be small and can be dropped without causing much error in the spatial Green's function.

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### Measurement of Dielectric Constant Using a Microstrip Ring Resonator

P. A. Bernard and J. M. Gautray

**Abstract**—A new approach for measuring the permittivity of dielectric materials by means of a microstrip ring resonator is presented. The method is used in conjunction with the variational calculation of the line capacitance of a multilayer microstriplike transmission line to compute the effective permittivity and hence the resonant frequency of the ring. The results are compared with measurements made in X-band waveguide cavity by cavity perturbation techniques.

#### I. INTRODUCTION

Microstrip ring resonators are frequently employed in microwave integrated circuit design. Resonant structures such as rectangular, circular, and ring resonators have been widely studied in oscillators and filters [1]-[4]. The resonator is a large ring that is several wavelengths long to avoid mutual inductance effects [5] and problems caused by end effects in rectangular microstrip resonators. What is more, these ring resonators have  $Q$  factors of about 250, compared with 100 for rectangular ones.

The method presented here is based on the fact that the effective permittivity will change if the alumina/air boundary is modified by placing a dielectric material above the alumina substrate, thereby changing the resonant frequency of the ring. The variational calculation of the line capacitance [6], [7] is used to compute the effective permittivity of the multilayer microstriplike ring resonator and hence the resonant frequency for several test materials.

It is well known that the dielectric constant varies with frequency. Since we are very concerned with this frequency dependence, the test material above the  $\text{Al}_2\text{O}_3$  substrate must be

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The authors are with the Universite de Bordeaux I, U.E.R. De Physique, Laboratoire De Physique Experimentale et Des Micro-Ondes, 351, Cours de la Liberation, 33405 Talence Cedex, France.

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